PNP SILICON PLANAR MEDIUM POWER HIGH GAIN TRANSISTOR

ZTX789A

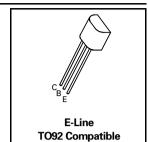
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FEATURES

- * 25 Volt V_{CEO}
- * Gain of 200 at I_C=2 Amps
- * Very low saturation voltage

APPLICATIONS

- * Darlington replacement
- * Battery powered circuits
- * Motor drivers



ABSOLUTE MAXIMUM RATINGS.

PARAMETER	SYMBOL	VALUE	UNIT
Collector-Base Voltage	V_{CBO}	-25	V
Collector-Emitter Voltage	V _{CEO}	-25	V
Emitter-Base Voltage	V _{EBO}	-5	V
Peak Pulse Current	I _{CM}	-8	Α
Continuous Collector Current	I _C	-3	Α
Practical Power Dissipation*	P _{totp}	1.5	W
Power Dissipation at T _{amb} =25°C derate above 25°C	P _{tot}	1 5.7	W mW/°C
Operating and Storage Temperature Range	T _j :T _{stg}	-55 to +200	°C

^{*}The power which can be dissipated assuming the device is mounted in a typical manner on a P.C.B. with copper equal to 1 inch square minimum

ELECTRICAL CHARACTERISTICS (at T_{amb} = 25°C)

PARAMETER	SYMBOL	MIN.	TYP.	MAX.	UNIT	CONDITIONS.
Collector-Base Breakdown Voltage	V _{(BR)CBO}	-25			V	I _C =-100μA
Collector-Emitter Breakdown Voltage	V _{(BR)CEO}	-25			V	I _C =-10mA*
Emitter-Base Breakdown Voltage	V _{(BR)EBO}	-5			V	I _E =-100μA
Collector Cut-Off Current	I _{CBO}			-0.1	μΑ	V _{CB} =-15V
Emitter Cut-Off Current	I _{EBO}			-0.1	μА	V _{EB} =-4V
Collector-Emitter Saturation Voltage	V _{CE(sat)}			-0.25 -0.45 -0.5	V V V	I _C =-1A, I _B =-10mA* I _C =-2A, I _B =-20mA* I _C =-3A, I _B =-100mA*
Base-Emitter Saturation Voltage	V _{BE(sat)}			-1.0	V	I _C =-1A, I _B =-10mA*
Base-Emitter Turn-On Voltage	V _{BE(on)}		-0.8		V	IC=-1A, V _{CE} =-2V*
Static Forward Current Transfer Ratio	h _{FE}	300 250 200 100		800		I _C =-10mA, V _{CE} =-2V I _C =-1A, V _{CE} =-2V* I _C =-2A, V _{CE} =-2V* I _C =-6A, V _{CE} =-2V*

ELECTRICAL CHARACTERISTICS (at T_{amb} = 25°C)

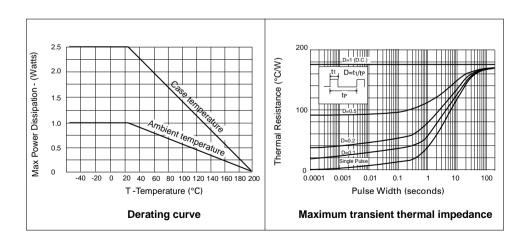
PARAMETER	SYMBOL	MIN.	TYP.	MAX.	UNIT	CONDITIONS.
Transition Frequency	f _T	100			MHz	I _C =-50mA, V _{CE} =-5V f=50MHz
Input Capacitance	C _{ibo}		225		pF	V _{EB} =-0.5V, f=1MHz
Output Capacitance	C _{obo}		25		pF	V _{CB} =-10V, f=1MHz
Switching Times	t _{on} t _{off}		35 400		ns ns	I _C =-500mA, I _{B1} =-50mA I _{B2} =-50mA, V _{CC} =-10V

^{*}Measured under pulsed conditions. Pulse width=300µs. Duty cycle ≤2%

THERMAL CHARACTERISTICS

PARAMETER	SYMBOL	MAX.	UNIT
Thermal Resistance: Junction to Ambient ₁ Junction to Ambient ₂ Junction to Case	R _{th(j-amb)1}	175	°C/W
	R _{th(j-amb)2} †	116	°C/W
	R _{th(j-case)}	70	°C/W

[†] Device mounted on P.C.B. with copper equal to 1 sq. Inch minimum.



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TYPICAL CHARACTERISTICS

